

Annex to certificate

Certificate Registr. No. 01 100 028556

Standard **ISO 9001:2008**

Location: **Carsem (M) Sdn. Bhd.**
Head Quarter & M Site: Jalan Lapangan Terbang,
P.O. Box 204, 30720 Ipoh Perak, Malaysia

Scope: Assembly, Test and Finishing of Semiconductor Components
- with Product Design and Development -

Certificate Registr. No.: 01 100 028556/01

Location: **Carsem (M) Sdn. Bhd. (S-Site)**
Lot 52986, Taman Meru Industrial, Estate, Jelapang,
P. O. Box 380, 30720 Ipoh Perak, Malaysia

Scope: Assembly, Test and Finishing of Semiconductor Components
- with Product Design and Development -

Certificate Registr. No.: 01 100 028556/02

Location: **Carsem Semiconductor (Suzhou) Co., Ltd.**
No. 408, Shen Hu Road in District 2, Suzhou Industrial Park,
JiangSu 215021, P. R. China

Scope: Assembly, Test and Finishing of Semiconductor Components
- with Product Design and Development -

Certificate Registr. No.: 01 100 028556/03

Hong Kong, 2009-07-03



TÜV Rheinland Cert GmbH
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